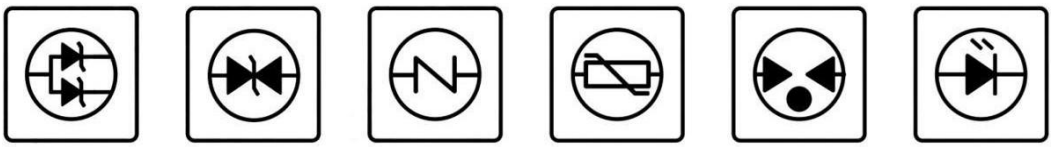
MSKSEMI 美森科
SEMICONDUCTOR



LM331CXF-MS

Product specification

GENERAL DESCRIPTION

The LM331CXF-MS is a voltage comparator usedinintegratedcircuit.Itprovidesloweroffset voltage, higher power supply voltage capability, lower power supply current, lower propagation delay, wider temperature range and higher ESD performance.

The chip supports single power and duel power supply. For duel power supply, the supply voltage ranges fro m ±1.5V to ±18V, and the VS is at least 1.5V higher than the input common-mode voltage. The output is co mpatible with TTL and CMOS, and the drain current is not affected by the power supply voltage. The output can be connected to other drain open circuit output to achieve the wired-and" relationship.

The LM331CXF-MS are available in Green SOT23-5. It operates over an ambient temperature range of -40° C to +125°C.

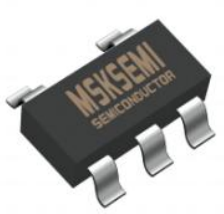
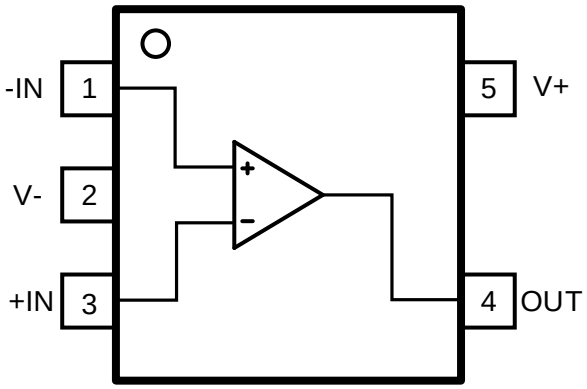
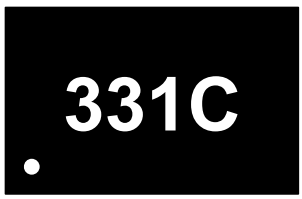
Features

- Wide Supply Range: 3V to 36V
- Low Inuput Offset: 2mV (Typ)
- LowQuiescent Current：
  75μA at Vs=5V
- Low Input Bias Current：1nA
- Input Common-Mode Voltage Range
- Includes Ground
- Open-Drain Output
- Short Response Time
- SIZE PACKAGES: SOT23-5

Applications

- Hysteresis Comparators
- Floor mopping robot
- One-way UPS
- Server PSU
- Cordless power tool
- Industrial Automation and Control
- Motor driver
- Instruments and apparatus

Pin Description AND MARKING

SOT-23-5	Pin Description	Marking
		

Pin Name	Pin Number	I/O	Description
	SOT23-5		
-IN	1	I	Inverting input
V-	2	—	Negative(lowest) power supply
+IN	3	I	Noninverting input
OUT	4	O	Output
V+	5	—	Positive (highest) power supply

Package/Order Information

ORDERING NUMBER	Op Temp(℃)	Package	Packing Option
LM331CXF-MS	-40°C~125°C	SOT23-5	3000PCS

Absolute Maximum Ratings(1)

		MIN	MAX	UNIT
Voltage	Supply, V_s=(V+) - (V-)		40	V
	Input pin (IN+, IN-) (2)	(V-) - 0.3	(V+) + 0.3	V
	Signal output pin (3)	(V-) - 0.3	(V+) + 0.3	V
Current	Signal Input pin (IN+, IN-) (2)	-10	10	mA
	Signal output pin (3)	-55	55	mA
Temperature	Operating Range	-40	125	°C
	Storage	-65	150	°C
	Junction		150	°C

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) Output terminals are diode-clamped to the power-supply rails. Output signals that can swing more than 0.5V beyond the supply rails should be current-limited to ±55mA or less.

(3) Short-circuit from output to Vcc can cause excessive heating and eventual destruction.

ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins (1)	±2000	V
		Charged device model (CDM), per JEDEC specification JESD22-C101, all pins (2)	±1000	V

(1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.

Recommended Operating Conditions

		MIN	MAX	UNIT
Supply voltage， Vs= (V+) - (V-)	Single-supply	3	36	V
	Dual-supply	±1.5	±18	V

SIMPLIFIED SCHEMATIC

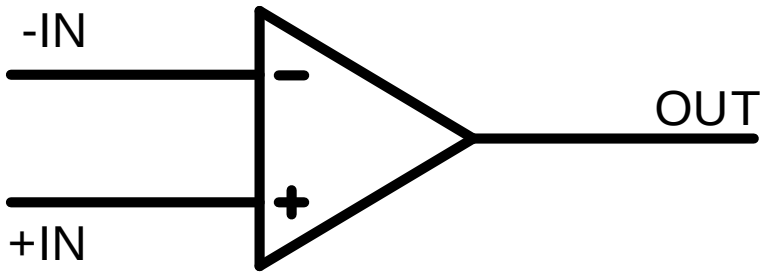


Figure 1. Simplified Schematic

ELECTRICAL CHARACTERISTICS

At T_A = 25°C, V_S=+5V V_{IN+}=V_S, V_{IN-}=1.4V, R_{PU}=10kΩ, unless otherwise noted.

Symbol	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
POWER SUPPLY						
Vs	Operating Voltage Range		3		36	V
I_Q	Quiescent Current /per channel	Vs=5V		75		μA
		Vs=36V		110		μA
INPUT CHARACTERISTICS						
Vos	Input offset voltage		-5	2	5	mV
I_B	Input Bias Current	V_{CM}=V_S/2		1		nA
I_{OS}	Input Offset Current			1		nA
V_{CM}	Common-Mode Voltage Range		V_{S-}		V_{S+}-1.5	V
A_{VD}	Large-signal Differential-voltage Amplification	V_S = 15 V, V_O = 1.4 V to 11.4 V, R_L ≥ 15 kΩ to V_S	50	200		V/mV
OUTPUT CHARACTERISTICS						
I_{OH}	High-level Output Current	V_{OH}=36V, V_{ID}=1V		2	30	nA
I_{OL}	Low-level Output Current	V_{OL}=1.5V, V_{ID}=-1V		30		mA
V_{OL}	Low-level Output Voltage	I_{OL}=4mA, V_{ID}=-1V		270		mV
DYNAMIC CHARACTERISTICS						
t_{RT}	Propagation Delay H To L	V_S=5V , R_{PU}=5.1kΩ, Overdrive =10mV		485		ns
		V_S=5V , R_{PU}=5.1kΩ, Overdrive =100mV		400		
	Propagation Delay L To H	V_S=5V , R_{PU}=5.1kΩ, Overdrive =10mV		360		
		V_S=5V , R_{PU}=5.1kΩ, Overdrive =100mV		90		

DETAILED DESCRIPTION

Overview

The LM331CXF-MS family of comparators can operate up to 36V on the supply pin. This standard device has proven ubiquity and versatility across a wide range of applications. This is due to its low power and high speed. The open-drain output allows the user to configure the output's logic low voltage (V_{OL}) and can be utilized to enable the comparator to be used in AND functionality.

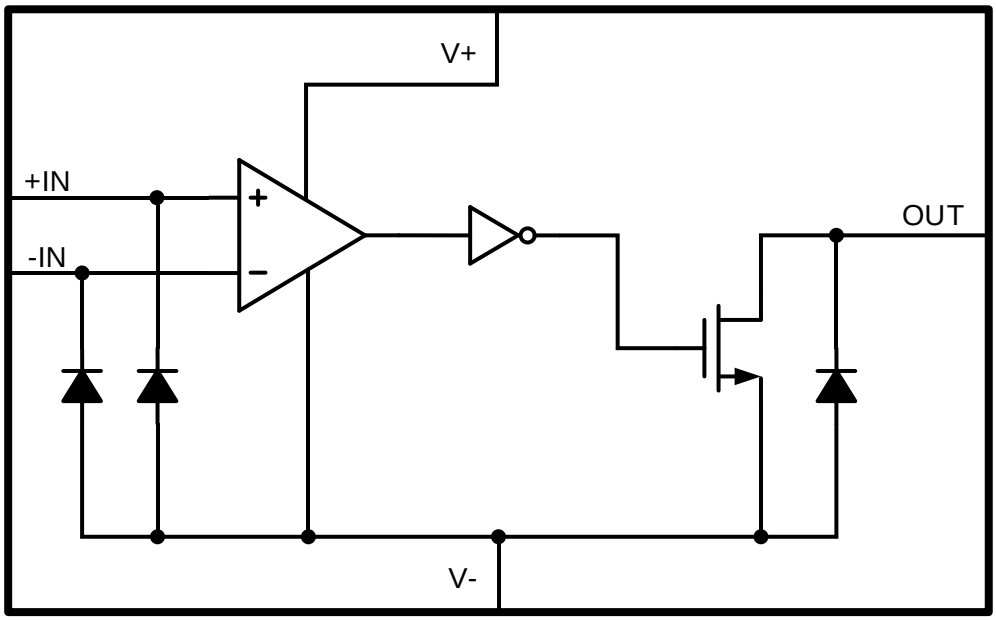
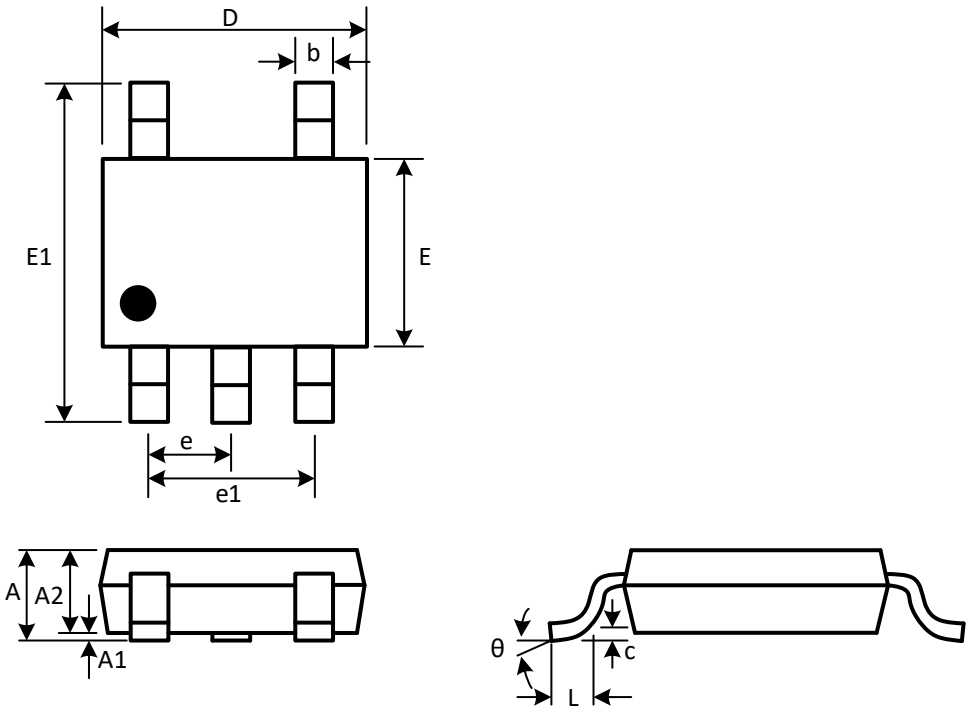


Figure 2. Functional Block Diagram

PACKAGE DESCRIPTION

SOT23-5



(Unit: mm)

Symbol	Min	Max
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.300	0.500
c	0.100	0.200
D	2.820	3.020
e	0.950(BSC)	
e1	1.800	2.000
E	1.500	1.700
E1	2.650	2.950
L	0.300	0.600
θ	0°	8°

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